

## HMC506LP4

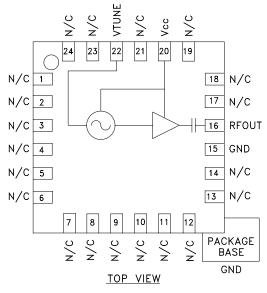
## MMIC VCO w/ BUFFER AMPLIFIER, 7.8 - 8.7 GHz

#### Typical Applications

Low noise MMIC VCO w/Buffer Amplifier for:

- VSAT Radio
- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- Military End-Use

#### **Functional Diagram**



#### **Features**

Pout: +14 dBm

Phase Noise: -103 dBc/Hz @100 KHz

No External Resonator Needed Single Supply: +3V @ 77 mA

QFN Leadless SMT Package, 16 mm<sup>2</sup>

#### **General Description**

The HMC506LP4 is a GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCO with integrated resonator, negative resistance device, varactor diode, and buffer amplifier. Covering 7.8 to 8.7 GHz, the VCO's phase noise performance is excellent over temperature, shock and vibration due to the oscillator's monolithic structure. Power output is +14 dBm typical from a single supply of +3.0V @ 77 mA. The voltage controlled oscillator is packaged in a leadless QFN 4 x 4 mm surface mount package.

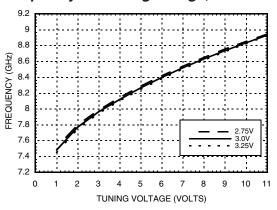
### Electrical Specifications, $T_A = +25^{\circ} C$ , Vcc = +3V

Parameter	Min.	Тур.	Max.	Units
Frequency Range		7.8 - 8.7		GHz
Power Output	11.0	14.0		dBm
SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RF Output		-103		dBc/Hz
Tune Voltage (Vtune)	1		11	V
Supply Current (Icc) (Vcc = +3.0V)		77		mA
Tune Port Leakage Current			10	μА
Output Return Loss		7		dB
Harmonics 2nd 3rd		-16 -28		dBc dBc
Pulling (into a 2.0:1 VSWR)		28		MHz pp
Pushing @ Vtune= +5V		78		MHz/V
Frequency Drift Rate		0.85		MHz/°C

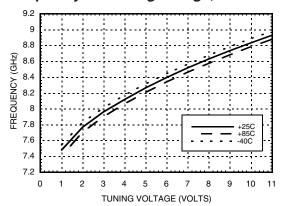


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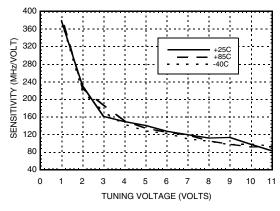
#### Frequency vs. Tuning Voltage, T= 25°C



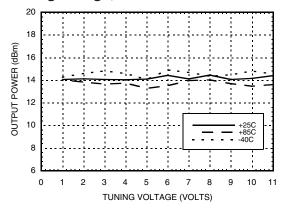
#### Frequency vs. Tuning Voltage, Vcc= +3V



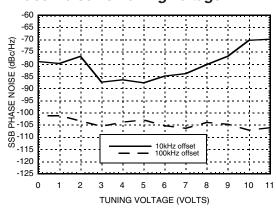
#### Sensitivity vs. Tuning Voltage, Vcc= +3V



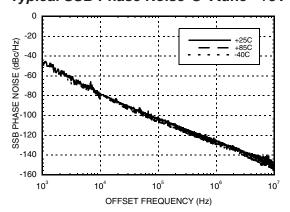
Output Power vs.
Tuning Voltage, Vcc= +3V



#### Phase Noise vs. Tuning Voltage



Typical SSB Phase Noise @ Vtune= +5V



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#### Absolute Maximum Ratings

Vcc	+3.5 Vdc	
Vtune	0 to +11V	
Channel Temperature	135 °C	
Continuous Pdiss (T = 85°C) (derate 6.07 mW/°C above 85°C)	303 mW	
Thermal Resistance (junction to ground paddle)	165 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	

	+3.5 Vdc
	0 to +11V
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#### Typical Supply Current vs. Vcc

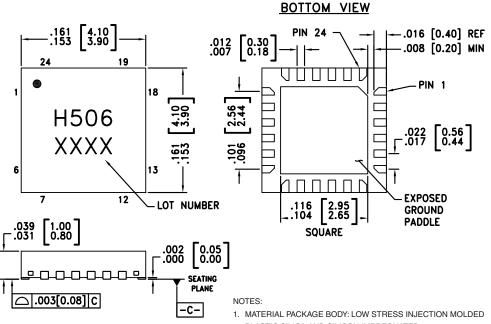
Vcc (V)	Icc (mA)
2.75	66
3.0	77
3.25	88

Note: VCO will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS** 

#### **Outline Drawing**



- PLASTIC SILICA AND SILICON IMPREGNATED.
- 2 LEAD AND GROUND PADDLE MATERIAL COPPER ALLOY
- 3. LEAD AND GROUND PADDLE PLATING: Sn/Pb SOLDER 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 7. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 9. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.
- 10. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.



# MMIC VCO w/ BUFFER AMPLIFIER, 7.8 - 8.7 GHz

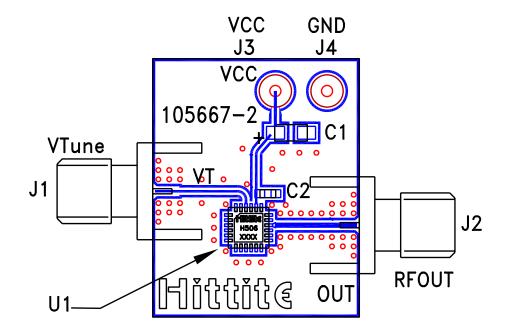
#### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1- 14, 17 - 19, 21, 23, 24	N/C	No Connection	
15	GND	This pin must be connected to RF & DC ground.	<u> </u>
16	RFOUT	RF output (AC coupled)	
20	Vcc	Supply Voltage Vcc= 3V	VCC 0 26pF
22	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	8nH 50 0 VTUNE 0 Cj= 7.8pF
	GND	Package bottom has an exposed metal paddle that must be RF & DC grounded.	<u> </u>



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#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 105706\*

Item	Description	
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J1 - J2	PC Mount SMA RF Connector	
J3 - J4	DC Pin	
C1	4.7 μF Tantalum Capacitor	
C2	10,000 pF Capacitor, 0603 Pkg.	
U1	HMC506LP4 VCO	
PCB**	105667 Eval Board	
** Circuit Board Material: Rogers 4350		

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

<sup>\*</sup> Reference this number when ordering complete evaluation PCB.





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Notes: